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Dimensions	
Chip Size	3640
L	9.1mm +/-0.4mm
W	10.2mm +/-0.4mm
T	1.4mm +/-0.15mm
B	1.27mm +/-0.4mm

Packaging Specifications	
Packaging	Bulk, Bag
Packaging Quantity	1

General Information	
Series	SMD Indust COG HVHT200C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable, Low Loss
Features	High Temp, Ultra-Stable, Low Loss
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	18 mg
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	0.022 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	5%
Voltage DC	1000 VDC
Dielectric Withstanding Voltage	1200 VDC
Temperature Range	-55/+200°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	45.4545 GOhms

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